ROHS COMPLIANT

APPROVAL SHEET

Customer:	
Part Number:	
Part No.:	11414016000.0002
Holder:	OCXO-14
Frequency:	16MHz
Manufacturer:	
Date:	2023-03-22

Prepared	Checked	Approved

(For Customer Use)

Acceptable	Non-Acceptable

Revision History

No.	Revised Date	Change Content	Approved	Remark
1.0	2023-3-22	Initial Release		

1. Scope

This document describes technical guidelines of product 11414016000.0002

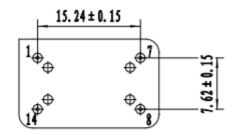
2. Electrical Characteristics

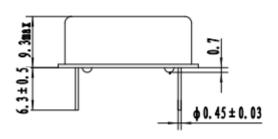
		SINEWAVE OUTPUT	OCXO-14			
PARAMETER	SYMBO L	CONDITIONS	MIN	TYPE	MAX	UNIT
Normal Frequency	Fn	AT		16		MHz
Absolute maxin	num ratings	S				
Maximum Supply Range	V _{cc}	-	-0.3		+6	V
Operating Temperature range	TA	-	-40		85	°C
Storage Temperature range			-55		125	°C
Power						
Operating Supply Voltage	Vcc		4.75	5	5.25	V
Turn-On Current		Nom Vcc			2.5	W
Steady state Current		Ta=25℃			1	W
Frequency Stab	oility					
Calibration		TA=25°C		±0.3	±0.5	ppm
Freq VS Temperature	TS	-40°C to 85°C			±300	ppb
Freq VS Time		Per day			±50	ppb
(Aging)		1st year			±1.5	ppm
		10 years			±4	ppm
Warm up time		time to ±0.5 of Fn			3	minutes
Electrical Frequ	iency Conti	rol		•		
Control Voltage Range	Vc	VC Transfer is positive monotonic	0		5	V

(Zi) EFC Linearity Output parameters Output signal Output load Output power Harmonic	- Output to ground Load=50 Ω Load=50 Ω	100	±5 sine wave	10	ppm ΚΩ %
Output parameters Output signal Output load Output power Harmonic	Output to ground Load=50 Ω	100		10	%
Output signal Output load Output power Harmonic	Output to ground Load=50 Ω			10	-
Output load Output power Harmonic	Output to ground Load=50 Ω				
Output power Harmonic	Output to ground Load=50 Ω				
Harmonic	Load=50 Ω		50		_
Output power Harmonic Spurious			H		Ω
	Load=50 Ω		5		dBc
Spurious	2000-00			-30	dBc
	Load=50 Ω			-75	dBc
	10Hz		-90		dBc/Hz
	100Hz		-115		dBc/Hz
Phase noise	1KHz		-135		dBc/Hz
	10KHz		-140		dBc/Hz
. crystal enclosure medi	resistance weld □cold weld				

4.Dimension:





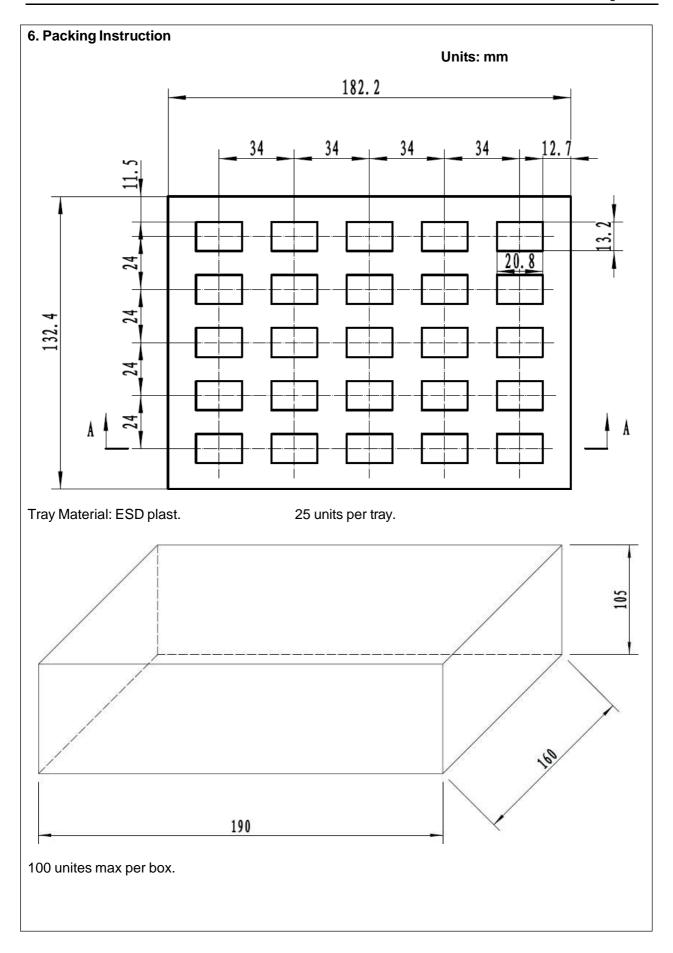


PIN/PAD	FUNCTION:
1	Control Voltage/NC
7	GND
8	Output
14	Power Supply

5. Marking

■ Laser Marking

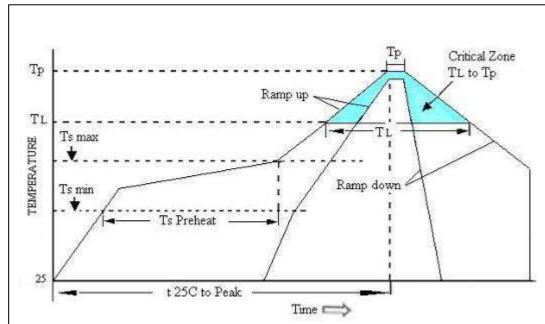
☐ Ink Marking



	Item	Condition	Specifications
1	Reflow	3X 240°C Peak	ΔF≤±0.2ppm
	Simulation	20 secs max above 240°C	
. 2	Power Cycl	100 Cycles	ΔF≤±0.2ppm
		-40°C, 30 minutes no power (off) and 30 minutes	
		powered (on)	
		Test product for functionality	
		Continue for another 250 cycles	
		Test product for functionality	
		Intenal visual and mechanical inspection	
. 3	Thermal Shock	Subject samples to temperature extremes of –40 and	∆F≤±0.2ppm
		+125C, 30 minute soaks at the temperature extremes,	
		10 seconds maximum transition time between	
		extremes. The test duration is 10 Cycles	
		GJB 360A-96 Method 107.	
. 4	Mechanical	IEC 68-2-27 Test Ea	ΔF≤±0.2ppm
	Shock		
. 5	Vibration	IEC 68-2-06 Test Fc	∆F≤±0.2ppm
. 6	Free drop	Drop from 10cm height on 3cm hard wooden board for 6	∆F≤±0.2ppm
		times	
		GB2423.8-1995 (idt IEC 68-2-32:1990) Method Ed。	
. 7	Aging	Bias oscillators at nominal voltage and subject	Per. Spec.
		oscillators to 25C for 1008 hours. Readings are to be	
		taken with espillator at 250 twice nor day. Determine	
		taken with oscillator at 25C twice per day. Determine	
		aging (frequency shift post 1008 hours minus initial	
		frequency). Use the results to predict long-term aging.	
		insquarity). Ode the results to predict long-term aging.	
. 8	Solderability	Precondition parts by steaming (over boiling water) for 8	A new uniform coating of
		D	solder shall cover a minimum
		hours OR age the parts at 150C for 16 hours	of 95% of the surface being
			immersed.

8.All products are RoHs compliant

9. Reflow Profile



High Temperature Infrared /Convection

Note:Temperature shown are applied to body of device

Ts max to T _L (Ramp-up Rate)	3°C/second max
Preheat	
Temperature Min(Ts Min)	150℃
Temperature Typical(Ts Typ)	175℃
Temperature Max.(Ts Max)	200℃
Time(ts)	60-180 seconds
Ram-up Rate(T _L to Tp)	3°C/second Max
Time Maintained Above:	
Temperature(T _L)	217℃
Time(T _L)	60-150seconds
Peak Temperature (Tp)	260°C Max for 10 seconds
Time within 5°C of actual peak(t _p)	20-40 seconds
Ramp-down Rate	6°C/seconds Max
Tune 25°C to Peak Temperature(t)	8 minutes Max
Moisture Sensitivity Level	Level 1

High Temperature Manual Soldering

Note:Temperature shown are applied to body of device